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IR Receiver Modules for Remote Control Systems



LINKS TO ADDITIONAL RESOURCES



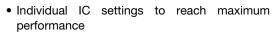


DESCRIPTION

This IR receiver series is optimized for short burst remote control systems in different environments. The customer can chose between different IC settings (AGC variants), to find the optimum solution for his application. The higher the AGC, the better noise is suppressed, but the lower the code compatibility.

The devices contain a PIN diode and a preamplifier assembled on a lead frame. The epoxy package contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding. These components have not been qualified to automotive specifications.

FEATURES





- · Immunity against noise (lamps, LCD TV, Wi-Fi)
- · Low supply current
- Photo detector and preamplifier in one package
- Supply voltage: 2.0 V to 5.5 V
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

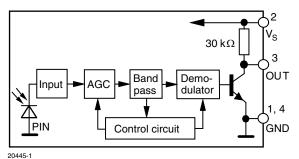


COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

DESIGN SUPPORT TOOLS

- 3D models
- Window size calculator

BLOCK DIAGRAM



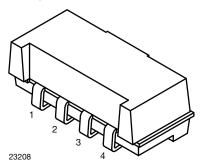


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MECHANICAL DATA

Pinning:

1, 4 = GND, $2 = V_S$, 3 = OUT

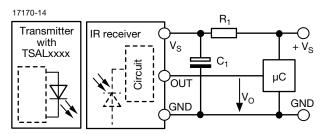


ORDERING CODE

Taping

TSOP75...WTT - top view taped, 2200 pcs/reel TSOP75...WTR - side view taped, 2300 pcs/reel

APPLICATION CIRCUIT



 R_1 and C_1 recommended in case there are strong ripple or spikes on the supply line.

PARTS TA	ABLE				
AGC		NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3)	VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5)		
	30 kHz	TSOP75330W	TSOP75530W		
Carrier frequency	33 kHz	TSOP75333W	TSOP75533W		
	36 kHz	TSOP75336W (1)	TSOP75536W		
	38 kHz	TSOP75338W (2)(3)(4)	TSOP75538W		
	40 kHz	TSOP75340W	TSOP75540W		
	56 kHz	TSOP75356W	TSOP75556W		
Package		Heimdall no lens			
Pinning		1, 4 = GND, 2 = V _S , 3 = OUT			
Dimensions (mm)		6.8 W x 3.0 H x 2.35 D			
Mounting		SMD			
Application		Remote control			
Best choice for		(1) MCIR (2) RECS-80 Code (3) r-map (4) XMP			
Special options		 Extended temperature range: www.vishay.com/doc?82738 Narrow optical filter: www.vishay.com/doc?81590 Wide optical filter: www.vishay.com/doc?82726 			

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		V _S	-0.3 to +6	V
Supply current		I _S	3	mA
Output voltage		Vo	-0.3 to (V _S + 0.3)	V
Output current		Io	5	mA
Junction temperature		T _j	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

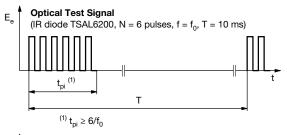


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ELECTRICAL AND O	ND OPTICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		Vs	2.0	-	5.5	V
Supply current	$E_{V} = 0, V_{S} = 3.3 V$	I _{SD}	0.25	0.35	0.45	mA
Supply current	$E_v = 40 \text{ klx, sunlight}$	I _{SH}	-	0.45	-	mA
Transmission distance	E_v = 0, test signal see Fig. 1, IR diode TSAL6200, I_F = 50 mA	d	-	16	-	m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2,$ test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Test signal: RC5 code	E _{e min.}	-	0.23	0.5	mW/m ²
Minimum madiance	Test signal: XMP code	E _{e min.}	-	0.3	0.6	mW/m ²
Maximum irradiance	t_{pi} - $3/f_o < t_{po} < t_{pi} + 3.5/f_o$, test signal see Fig. 1	E _{e max.}	30	-	-	W/m ²
Directivity	Angle of half transmission distance	Ψ1/2	-	± 75	-	0

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



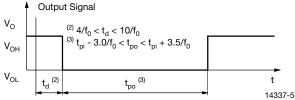
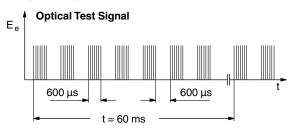


Fig. 1 - Output Active Low



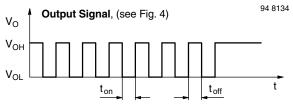


Fig. 3 - Output Function

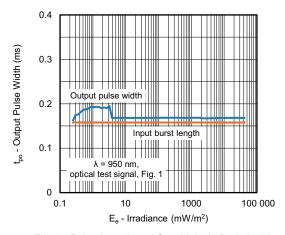


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

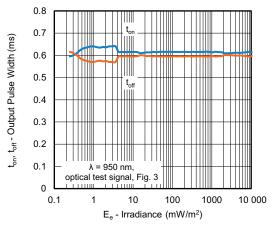


Fig. 4 - Output Pulse Diagram



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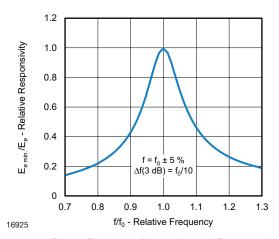


Fig. 5 - Frequency Dependence of Responsivity

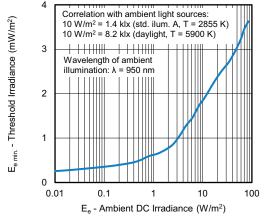


Fig. 6 - Sensitivity in Bright Ambient

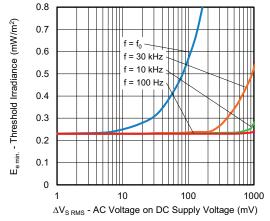


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

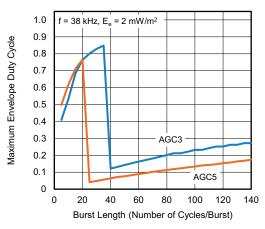


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

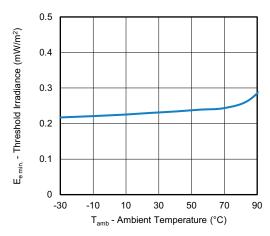


Fig. 9 - Sensitivity vs. Ambient Temperature

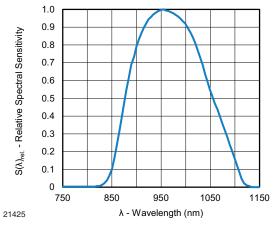


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

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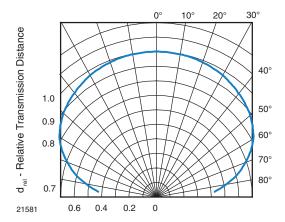


Fig. 11 - Horizontal Directivity

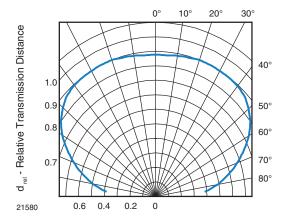


Fig. 12 - Vertical Directivity

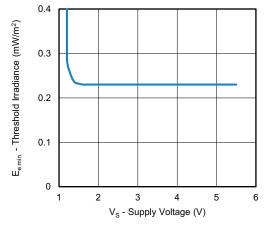


Fig. 13 - Sensitivity vs. Supply Voltage



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SUITABLE DATA FORMAT

The TSOP753..W, TSOP755..W series are designed to suppress spurious output pulses due to noise or disturbance signals. Data and disturbance signals can be distinguished by the devices according to carrier frequency, burst length and envelope duty cycle. The data signal should be close to the band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP753..W, TSOP755..W in the presence of a disturbance signal, the sensitivity of the receiver is reduced to insure that no spurious pulses are present at the output. Some examples of disturbance signals which are suppressed are:

- DC light (e.g. from tungsten bulb or sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated pattern from fluorescent lamps with electronic ballasts (see Fig. 14 or Fig. 15)

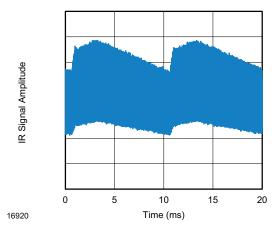


Fig. 14 - IR Disturbance from Fluorescent Lamp With Low Modulation

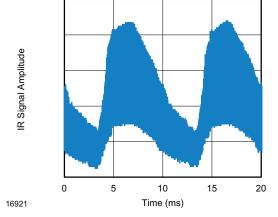


Fig. 15 - IR Disturbance from Fluorescent Lamp With High Modulation

	TSOP753W	TSOP755W
Minimum burst length	6 cycles/burst	6 cycles/burst
After each burst of length a minimum gap time is required of	6 to 35 cycles ≥ 10 cycles	6 to 20 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	35 cycles > 9 x burst length	20 cycles > 25 x burst length
Maximum number of continuous short bursts/second	2000	2000
MCIR code	Preferred	No
XMP code	Preferred	Yes
RECS-80 code	Preferred	Yes
r-map code	Preferred	Yes
Suppression of interference from fluorescent lamps	Fig. 14 and Fig. 15	Fig. 14 and Fig. 15

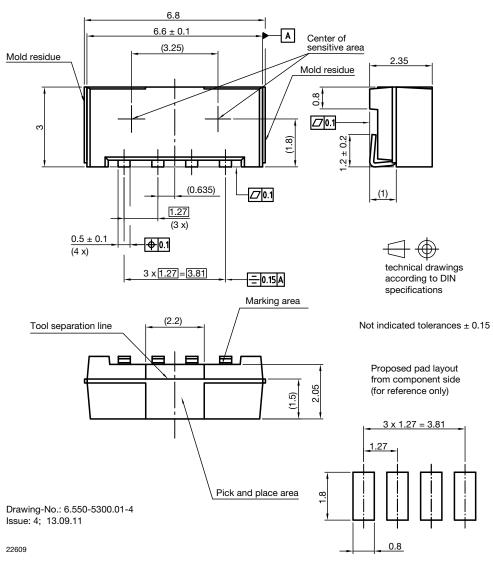
Note

• For data formats with long bursts please see the datasheet for TSOP752..W, TSOP754..W



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PACKAGE DIMENSIONS in millimeters



ASSEMBLY INSTRUCTIONS

Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

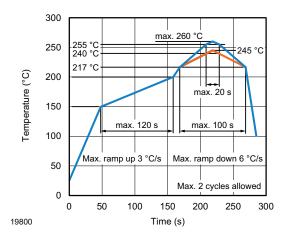
Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

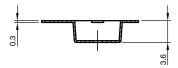


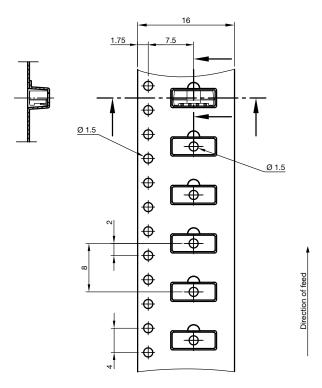
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VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSOP..TR DIMENSIONS in millimeters





Drawing-No.: 9.700-5342.01-4 Issue: 2; 12.06.13

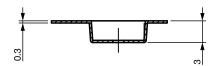


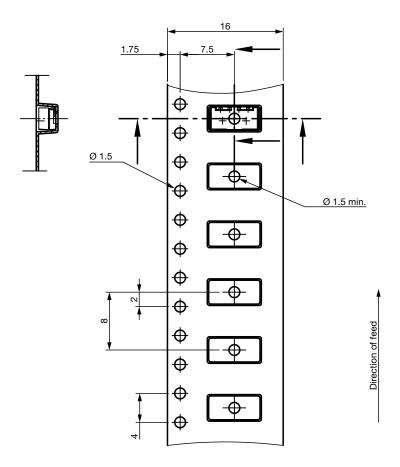
Rev. 2.3, 17-May-2024 Document Number: 82497 8



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TAPING VERSION TSOP..TT DIMENSIONS in millimeters





Drawing-No.: 9.700-5341.01-4

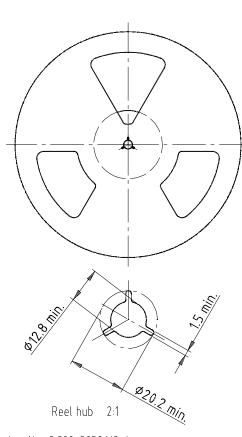
Issue: 3; 06.10.15

technical drawings according to DIN specifications



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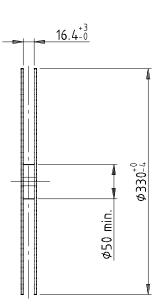
REEL DIMENSIONS in millimeters



Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734



Form of the leave open of the wheel is supplier specific.

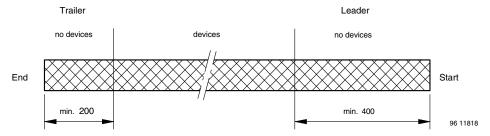
Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

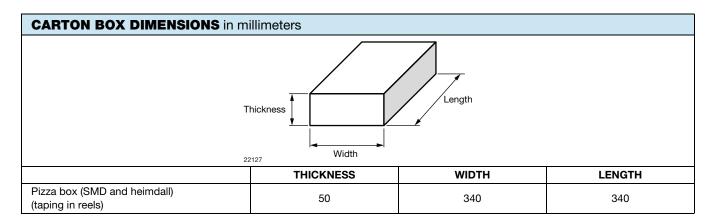
According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle



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OUTER PACKAGING

The sealed reel is packed into a pizza box.



LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

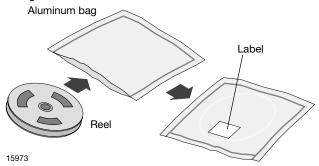
VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)				
PLAIN WRITING	ABBREVIATION	LENGTH		
Item-description	-	18		
Item-number	INO	8		
Selection-code	SEL	3		
LOT-/serial-number	BATCH	10		
Data-code	COD	3 (YWW)		
Plant-code	PTC	2		
Quantity	QTY	8		
Accepted by	ACC	-		
Packed by	PCK	-		
Mixed code indicator	MIXED CODE	-		
Origin	xxxxxxx+	Company logo		
LONG BAR CODE TOP	TYPE	LENGTH		
Item-number	N	8		
Plant-code	N	2		
Sequence-number	X	3		
Quantity	N	8		
Total length	-	21		
SHORT BAR CODE BOTTOM	TYPE	LENGTH		
Selection-code	X	3		
Data-code	N	3		
Batch-number	X	10		
Filter	-	1		
Total length	-	17		



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DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

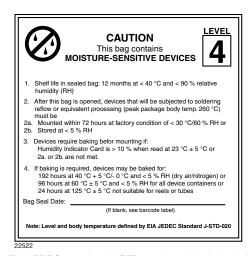
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen)

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

BAR CODE PRODUCT LABEL (example)



22178



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